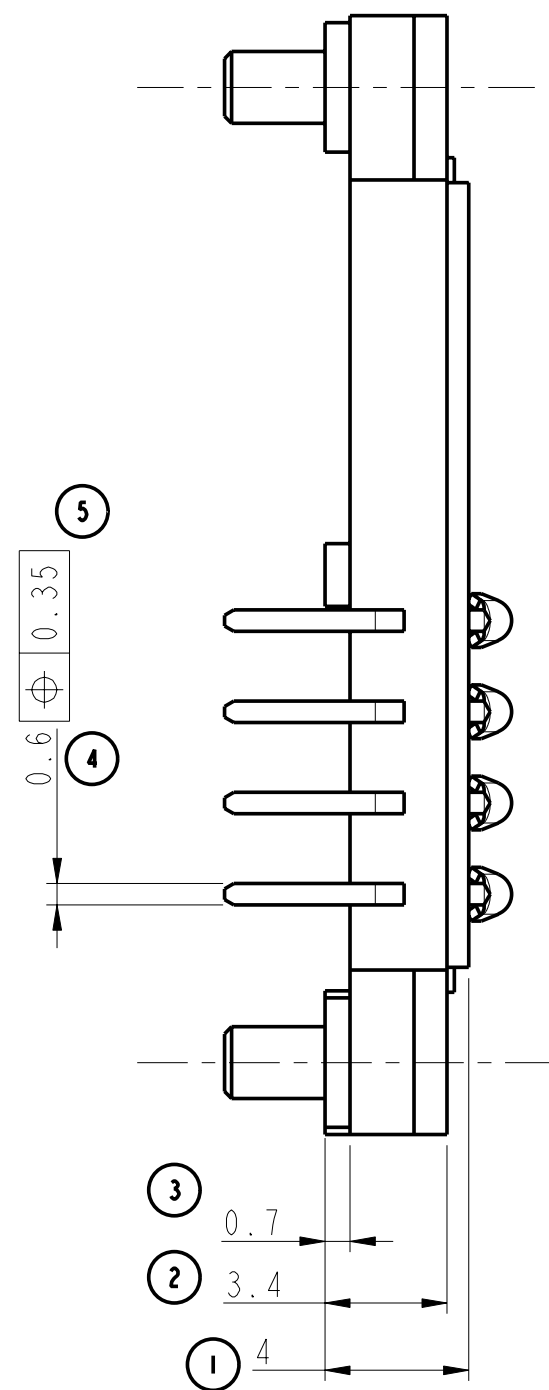
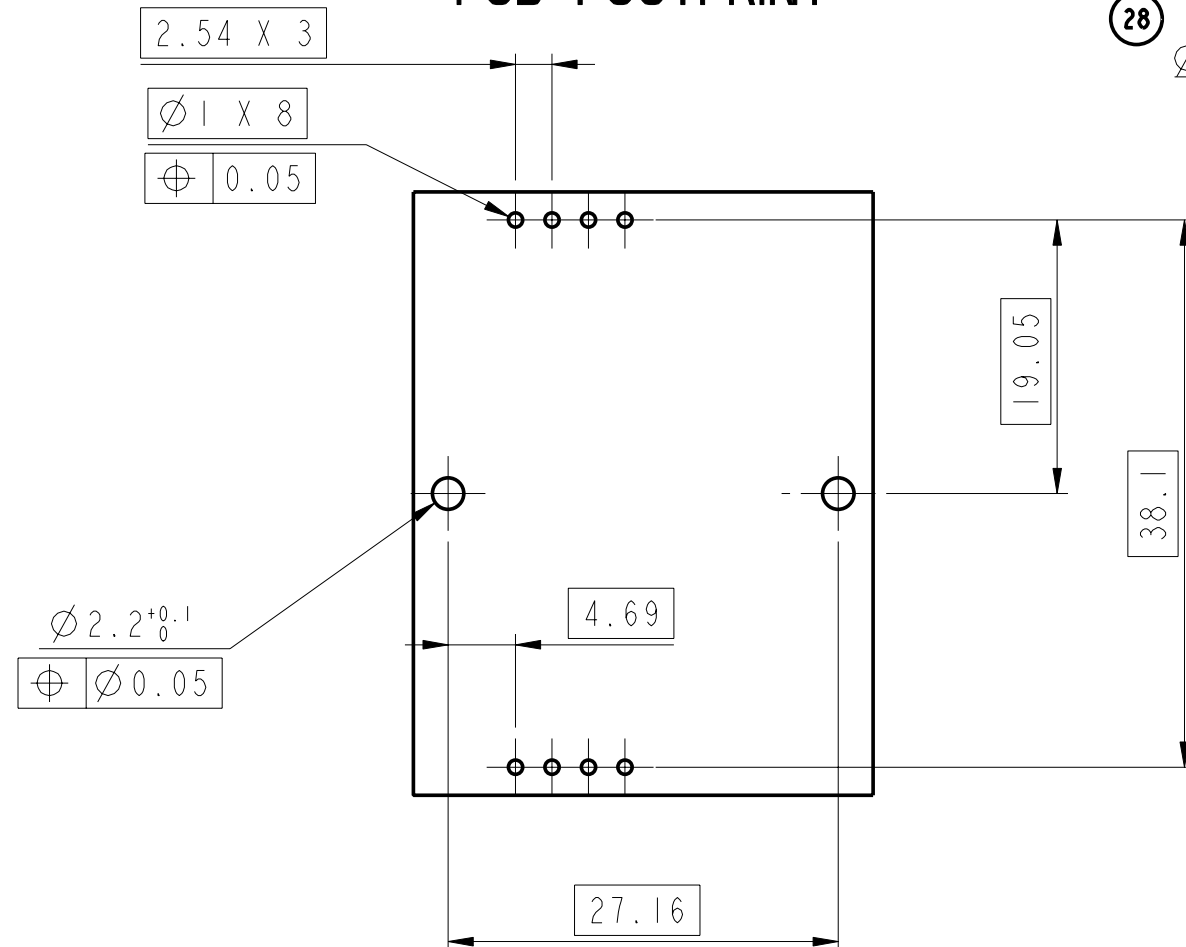


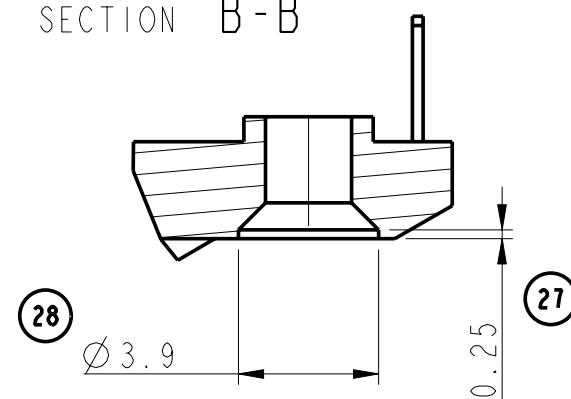
CATALOGUE NUMBER	LEAD FREE VERSION
7832C0425X01	7832C0425X01LF



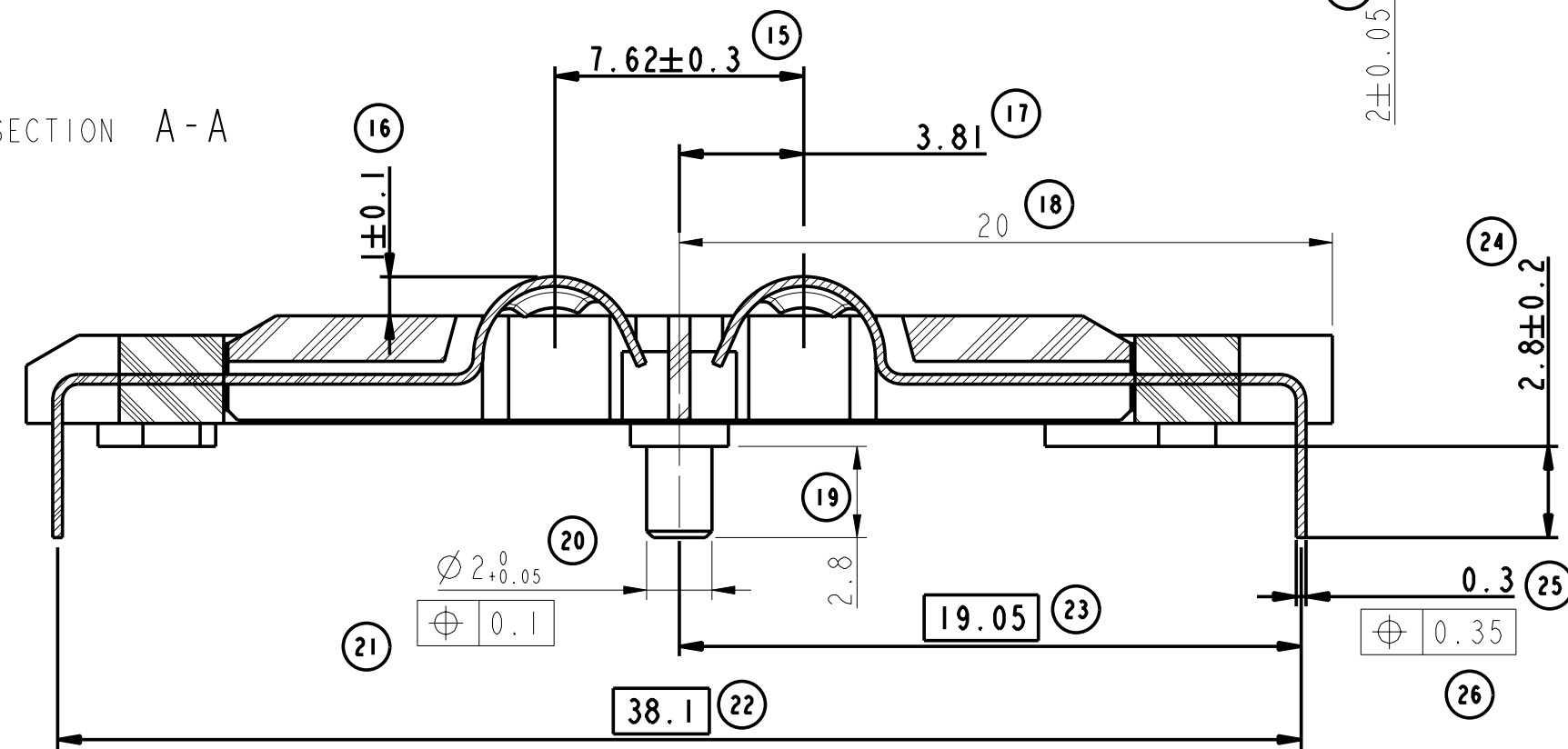
IMPLANTATION C.I PCB FOOTPRINT



SECTION B-B



SECTION A-A



LEAD FREE VERSION:

"This product meets European Union Directives and other country regulations as described in GS-22-008"

The housing will withstand exposure to 260°C peak temperature for 3-5seconds in a wave solder application with a 1.6mm minimum thick circuit board.

Use protective adhesive tape (Kapton or Teflon) or protective metallic devices on the areas which are directly exposed to wave soldering as it is used in classical leaded wave soldering

Sn Matte plating on solder tail for Lead Free Versions

General Tolerances	
0 to 10mm:	±0.1mm
10 to 30mm:	±0.15mm
30 to 60mm:	±0.2mm
60 and more:	±0.3mm

rev	ecn no	dr	date
E	105-0167	NT	2005/09/24
F	106-0084	SSC	2006/06/21
-	-	-	-
-	-	-	-
-	-	-	-
-	-	-	-

www.fciconnect.com			surface -	tolerance std	projection	mm
			ISO 1302	ISO 406 ISO 1101	size	
			TOLERANCES UNLESS OTHERWISE SPECIFIED			Scale
Dr	D LEGRAND	2002/04/29	ANGULAR	0.X	±	5:1
Eng	F TISSERAND	2002/04/29	LINEAR	0.XX	±	
Chr	DILIP THOMAS	2006/06/21	0° ±°	0.XXX	±	
Appr	K.V.SIVADAS	2006/06/21	Product family SMART CARD			ECN 106-0084
FCI			Module 8 CONTACTS			Spec ref -
C04			dwg no VRW11376			Rev. F
catalog no 7832C0425X01			CUSTOMER			sheet 1 of 1